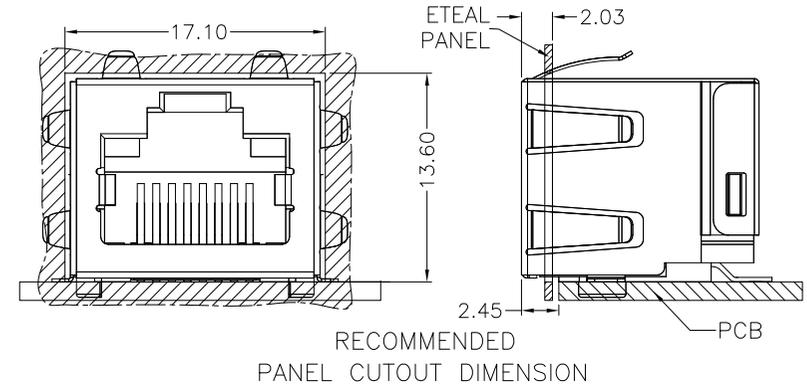
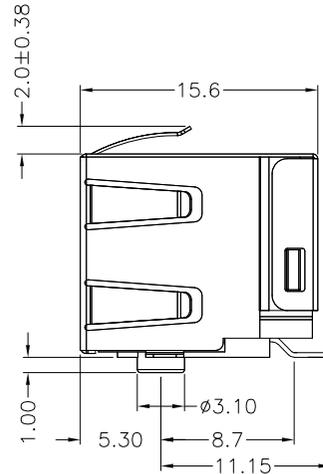
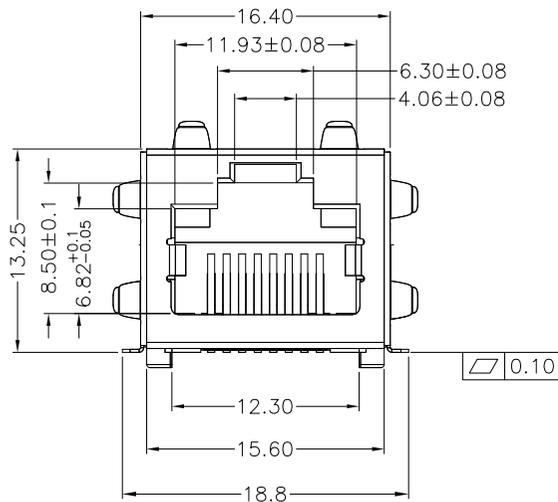


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2015/03/11	Phebe Su
A1			Add DIM and panel	2015/09/03	Phebe Su
A2			Add Part Number	2020/11/30	Hanson



NOTES:

1. MATERIALS:

HOUSING: LCP, UL 94V-0, BLACK.

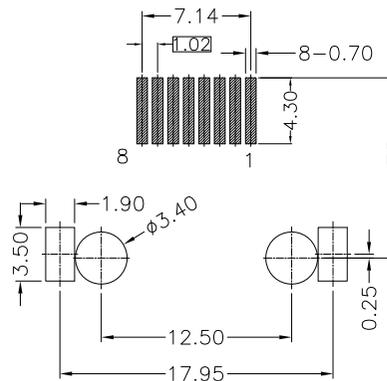
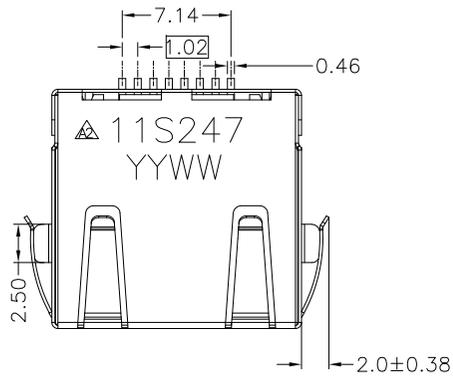
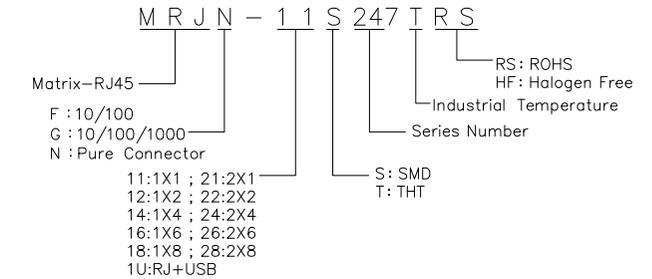
CONTACTS: T=0.30 mm PHOSPHOR BRONZE, 50u" NICKEL UNDERPLATE 100u" MATTE TIN ON SOLDERTAIL GOLD 6U" ON CONTACT AREA.

SHELL: BRASS, T=0.20mm

2. OPERATING TEMPERATURE: -40°C ~ +85°C

3. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F

ORDER INFORMATION :



RECOMMENDED PCB LAYOUT
COMPONENT SIDE
TOLERANCE ±0.05



Matrix Electronics Co.,Ltd

TOLERANCE: X.X X.XX ±0.38 X.XXX ±0.25 X.XXX ±0.13 ANGLE: ±3°	DESIGN BY : Hanson Huang	DATE : 2020/11/30	PART NAME: RJ45 1X1 PCB JACK W/O LED SMT TYPE
APPROVED BY1: Richard Hsieh	DATE : 2020/11/30	PART NO. MRJN-11S247TRS	MOLD NO. NA
APPROVED BY2: Richard Hsieh	DATE : 2020/11/30	DRAW NO.	SHEET NO. 1 OF 1